

Silicon Photomultipliers for the LHCb Upgrade Scintillating Fibre Tracker

Presented by Guido Haefeli

EPFL Lausanne, Switzerland, NDIP, 4.July 2014, Tours

(On behalf of the LHCb SciFi Tracker group)

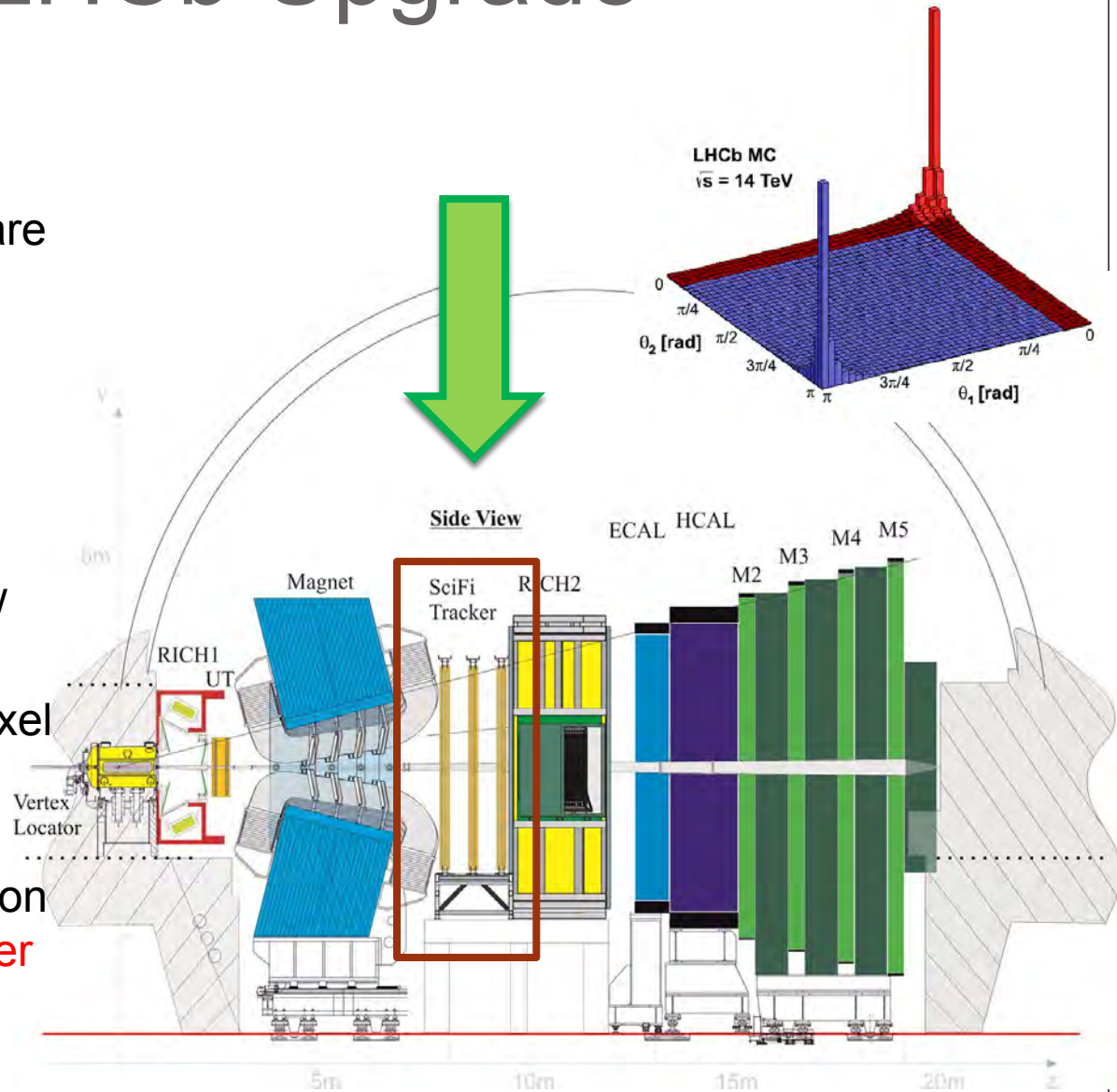


The LHCb Upgrade

New data acquisition scheme
40MHz event rate – no hardware trigger to get high efficient software trigger!

As a consequence:

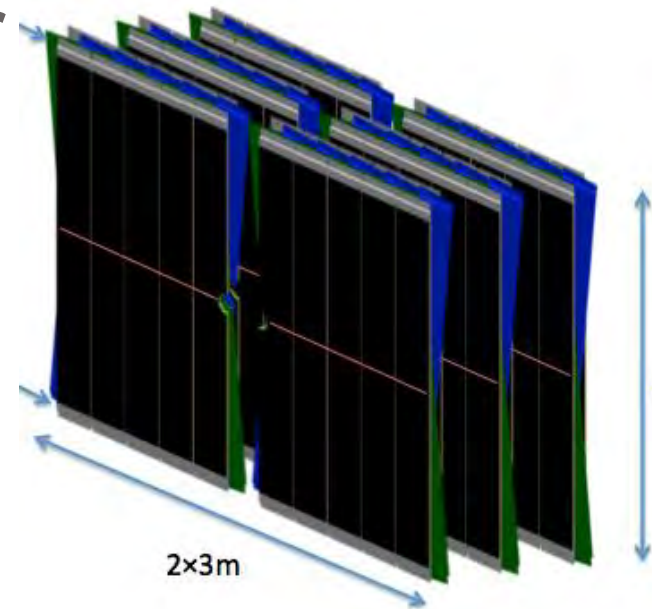
- Replace most of the FE electronics to cope with new readout scheme.
- **Replace the VELO** with a pixel detector to cope with higher multiplicity.
- Replace other trackers, silicon strip (UT) and a **SciFi Tracker** for (IT and OT).



The LHCb SciFi Tracker

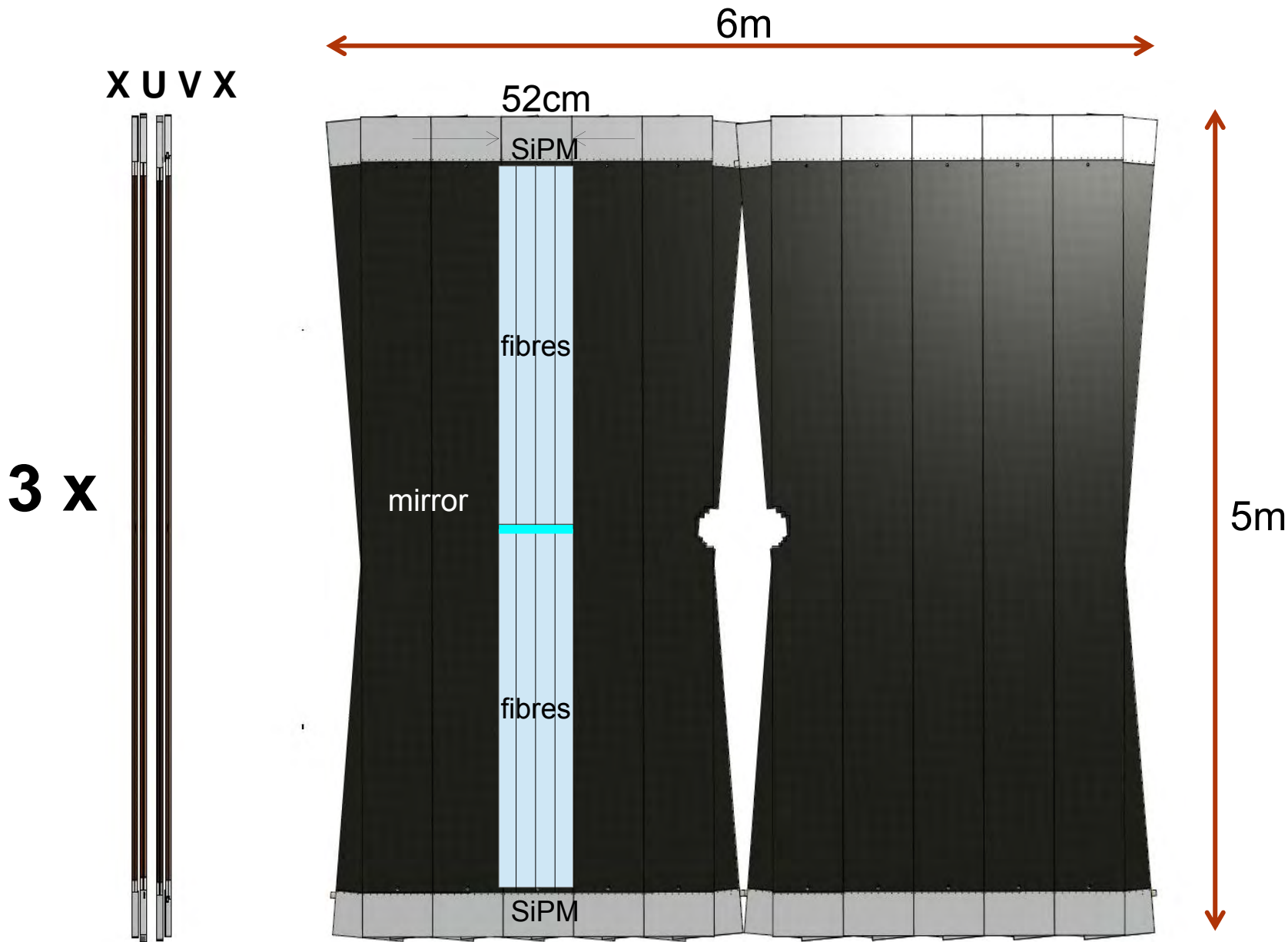
Technical Design Report:

LHCb Tracker Upgrade Technical Design Report,
LHCb Collaboration, LHCb-TDR-015, **Feb. 2014**.



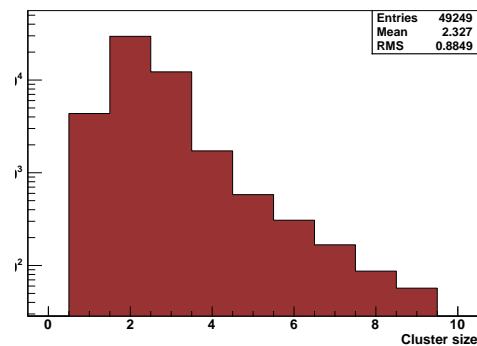
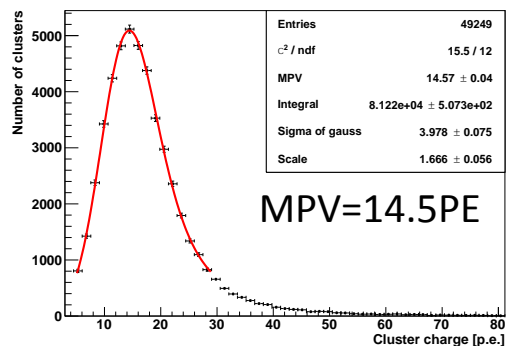
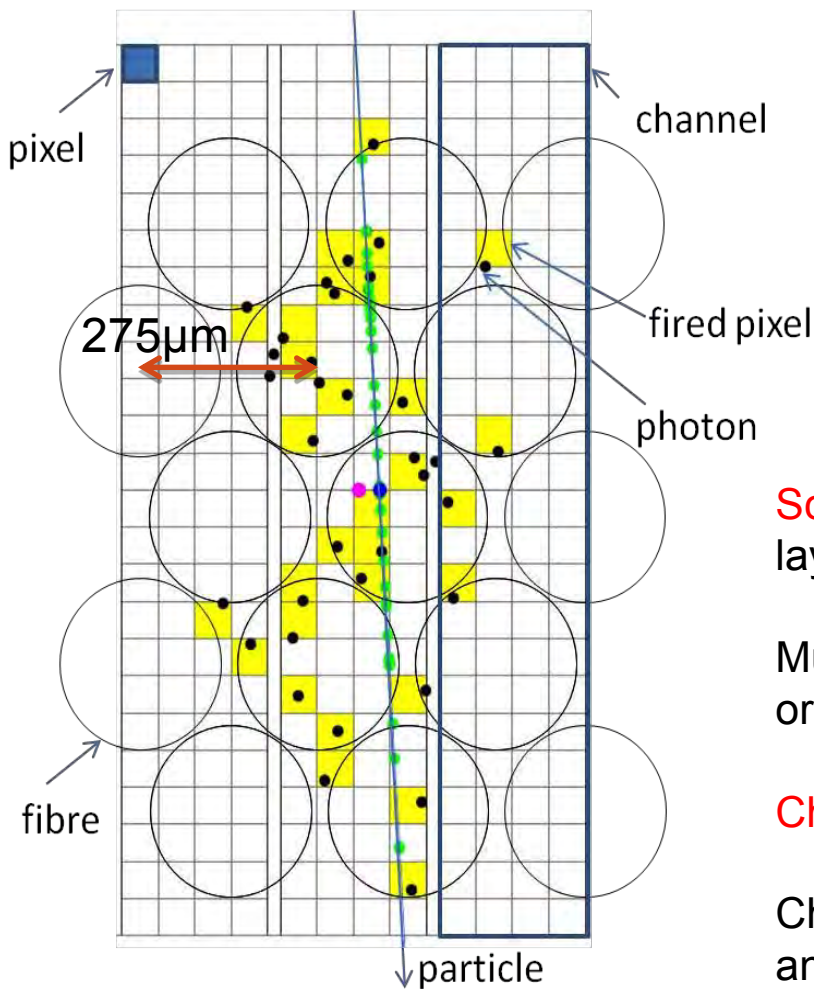
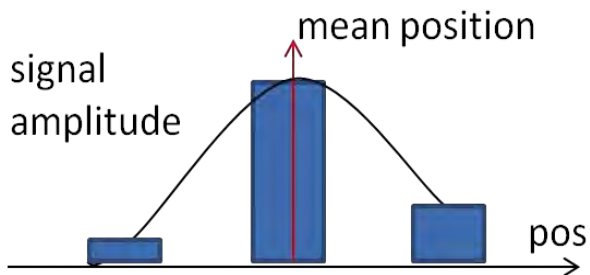
Requirements on detector performances:

- ❑ **Hit detection efficiency** greater than 98%, with noise less than 10% of signal
- ❑ **Spatial resolution** better than 100 μm
- ❑ Operation at 25 ns interaction rate, **40 MHz readout**
- ❑ **High occupancy**, up to 2.5 clusters for a detector array of 128 channels (32mm) in the hottest region
- ❑ **Low material** with $X/X_0 \leq 1\%$ per detection layer
- ❑ **Radiation environment**, fibres up to 35 kGy, SiPMs $6 \times 10^{11} n_{\text{eqv}}/\text{cm}^2$ fluence (with neutron shield) + 100 Gy ionising dose



U & V at 5°

SciFi working principle



Threshold based clustering algorithm is used to calculate the hit position
 Typical signal produced by a traversing particle is larger than one channel

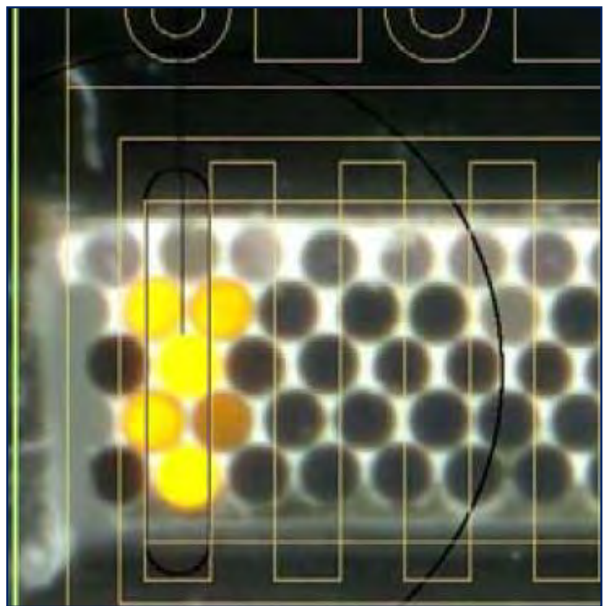
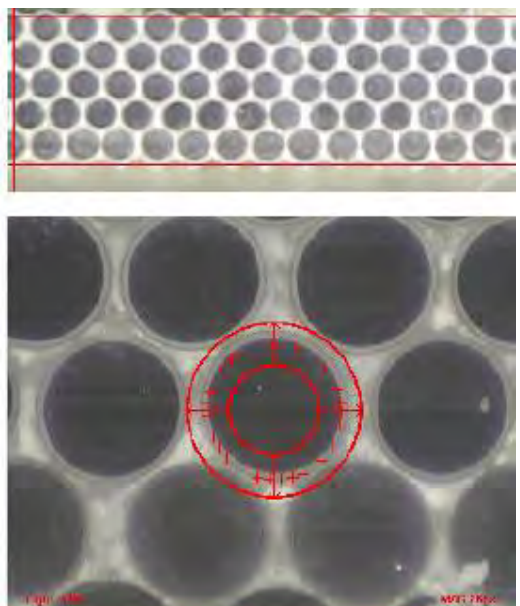
Scintillating fibres: 250 μ m diameter, 2.5m long, 6 layers near the beam-pipe and 5 everywhere else

Multichannel array of SiPM 128 channels (Hamamatsu or KETEK devices under development)

Channel: size 0.25 \times 1.5mm², 96 pixels (57.5 \times 62.5 μ m²)

Channel and fibres are not aligned (250 μ m channel and 275 μ m fibre pitch)

Fibre mat views

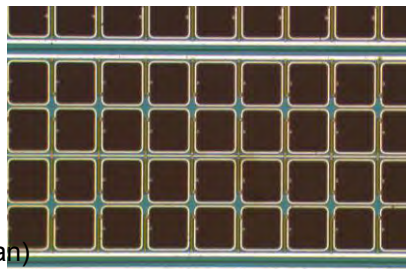


Important characteristics of the SiPMs for the LHCb SciFi Tracker

- ❑ **High PDE!** The 2.5m long fibres and the radiation damage of the fibres in the center of the detector, reduce the light output. We need typically 12-13 PE at the end of lifetime to get 98% efficiency!
- ❑ **Low x-talk!** The noise cluster rate increases exponentially with the x-talk probability.
- ❑ **Support the radiation environment!** DCR increases with neutron fluence, best possible technology is desired.
- ❑ **Small temperature dependence!** The operation temperature of the detector is set to $-40\text{ }^{\circ}\text{C}$. Temperature non-uniformity can be allowed if dependence is small.
- ❑ **Small dead regions!** Dead regions at the edges between adjacent SiPM arrays reduce the overall hit detection efficiency.
- ❑ **Thin entrance window!** The entrance window defuses the light and therefore the thick window increases the cluster size and makes the spatial resolution worse.

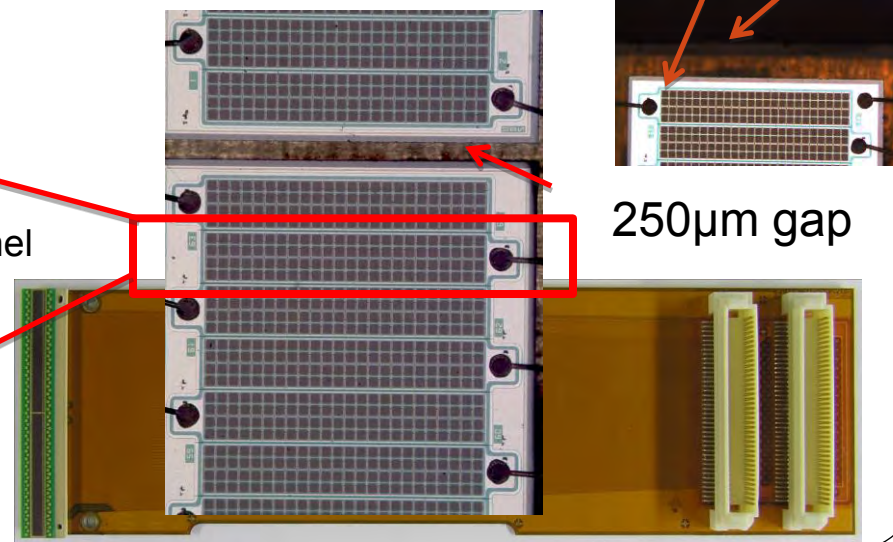
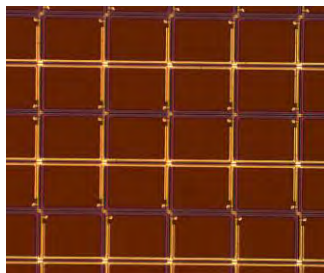


Hamamatsu (2010)
(Hamamatsu Photonics K.K., Japan)

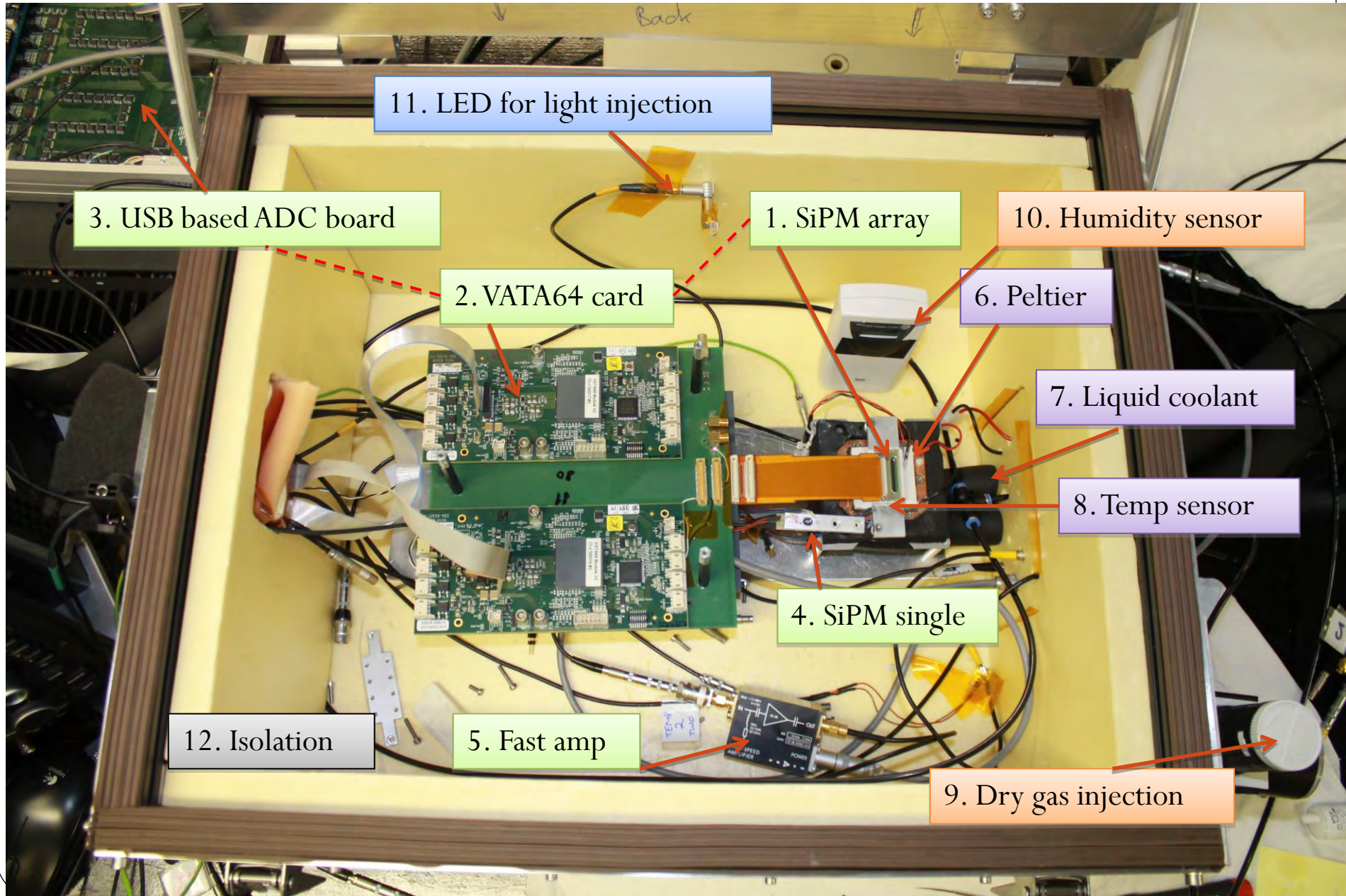


Channel

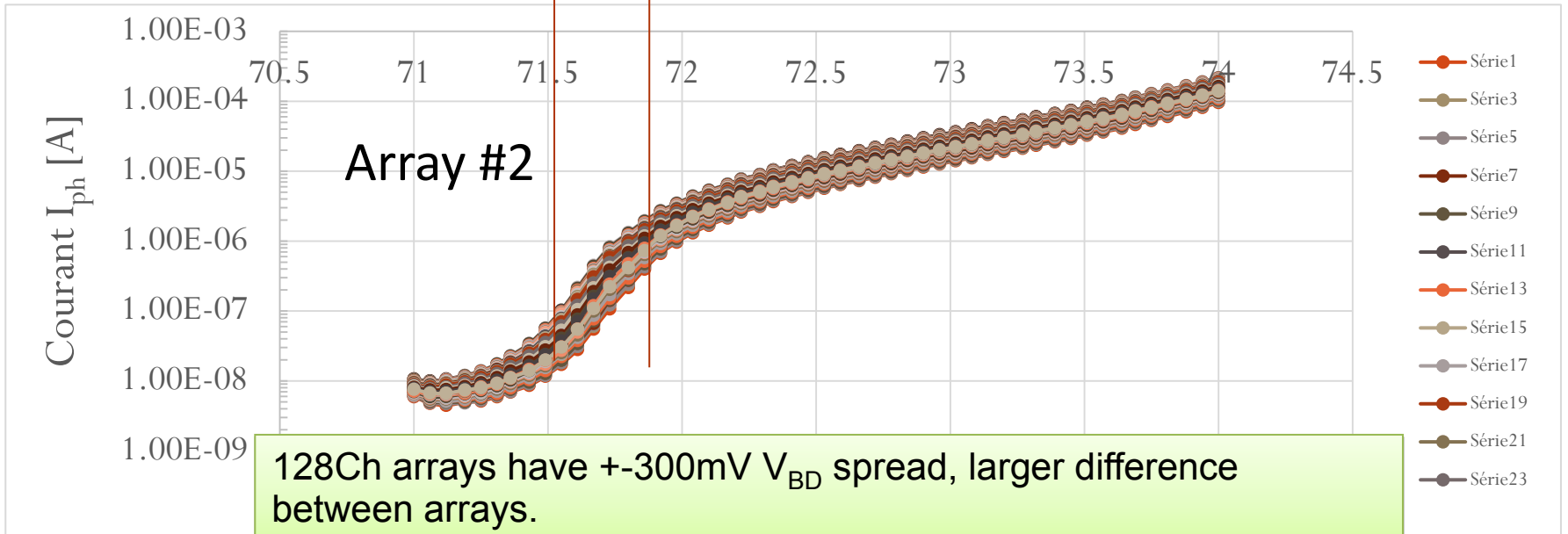
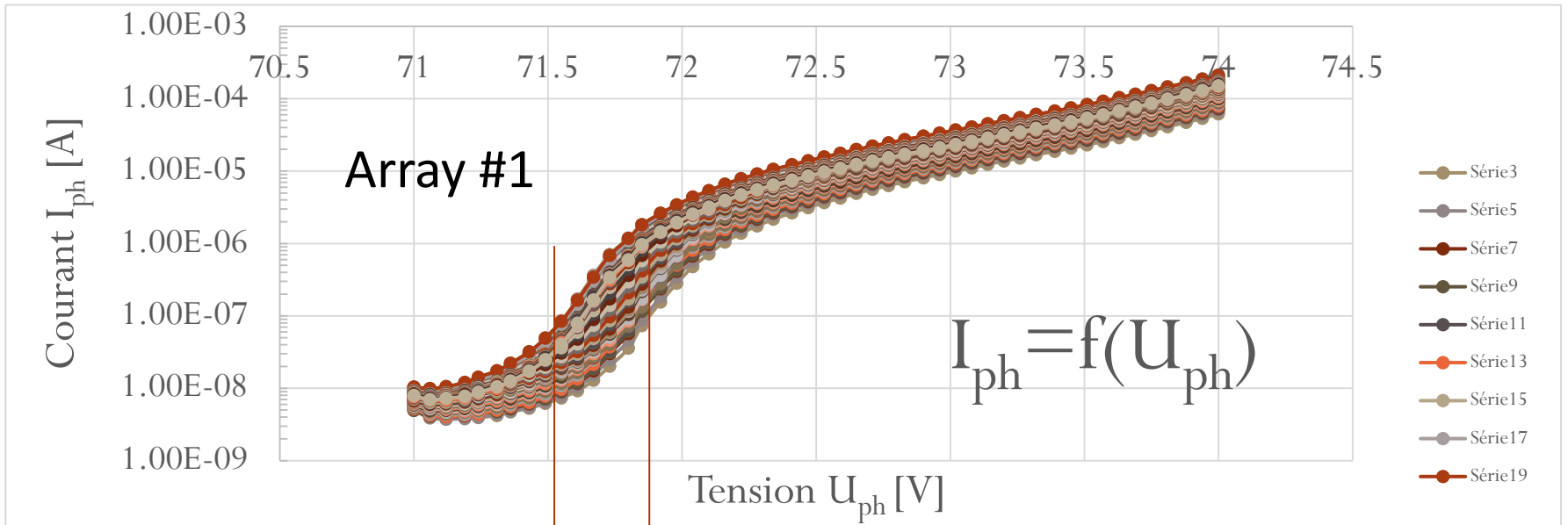
KETEK (highest possible fill factor)
(KETEK GmbH, Germany)



Cold box for SiPM characterization

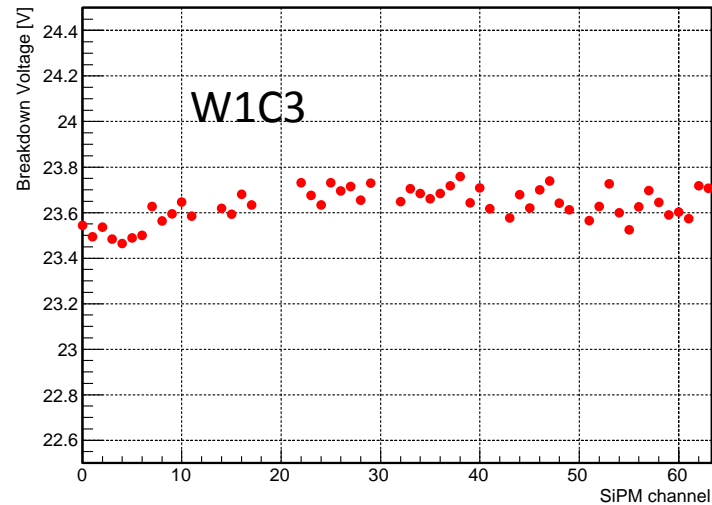
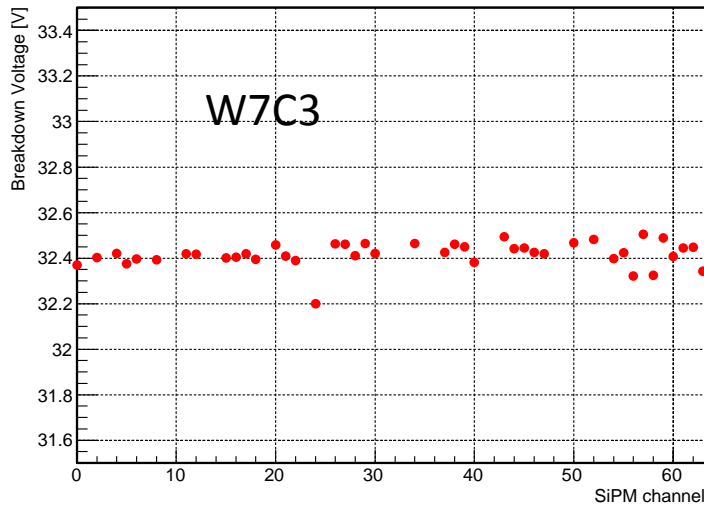


Hamamatsu V_{BD} uniformity 128CH

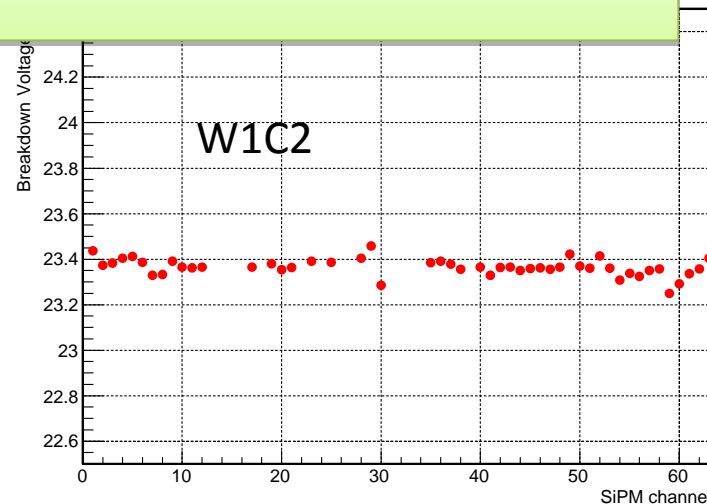
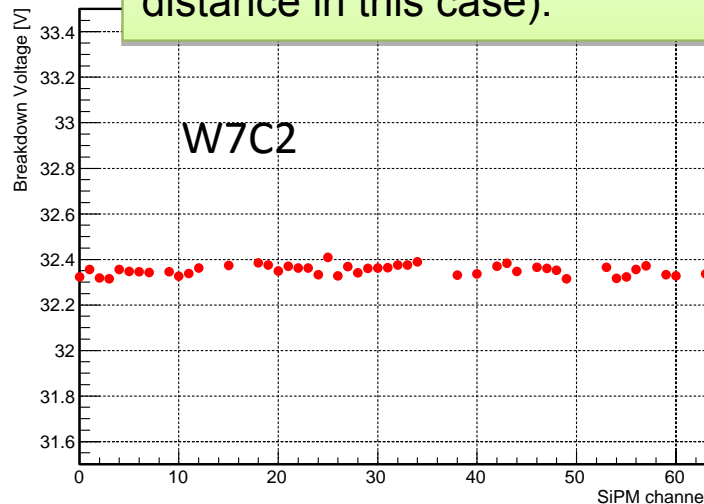


128Ch arrays have $\pm 300\text{mV}$ V_{BD} spread, larger difference between arrays.

KETEK channel-to-channel uniformity



For KETEK devices the VBD is uniform to $\pm 100\text{mV}$, it is probably the measurement that has more fluctuations (measure photo peak distance in this case).



General characteristics

Detector type	Pixel size [μm^2]	T_c [mV/K]	V_{BD} [V]	Over-voltage [V]*	Gain [e/PE]
H, S10362-11-050C	50 × 50	56	69	1.3	0.75*10 ⁶
H, with trench (2013)	50 × 50	53	55	3.5	2.0*10 ⁶
KETEK, W1C2, with trench	60 × 62.5	15	23.5	3.5	8.5*10 ⁶
KETEK, W1C3, with trench	82.5 × 62.5	15	23.5	3.5	12.0*10 ⁶

* Possible operation point for SciFi application (note that the DCR increases strongly with over-voltage)

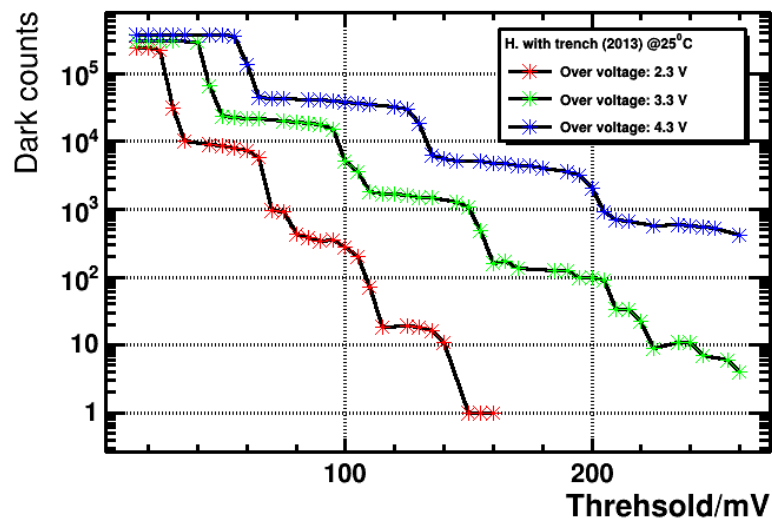
- ❑ Detectors with trenches can be operated at **higher over-voltage (3.5V)** reaching better relative gain uniformity.
- ❑ **Low T_c** in combination with **high over-voltage** reduces temperature dependence of the gain to below 1% per K.
- ❑ **Good gain uniformity** allows to operate all detectors at the same bias voltage. Tuning of the gain can be restricted to detector arrays.

KETEK devices have very low temperature dependence, about 10 times better than S10362-11-050C!

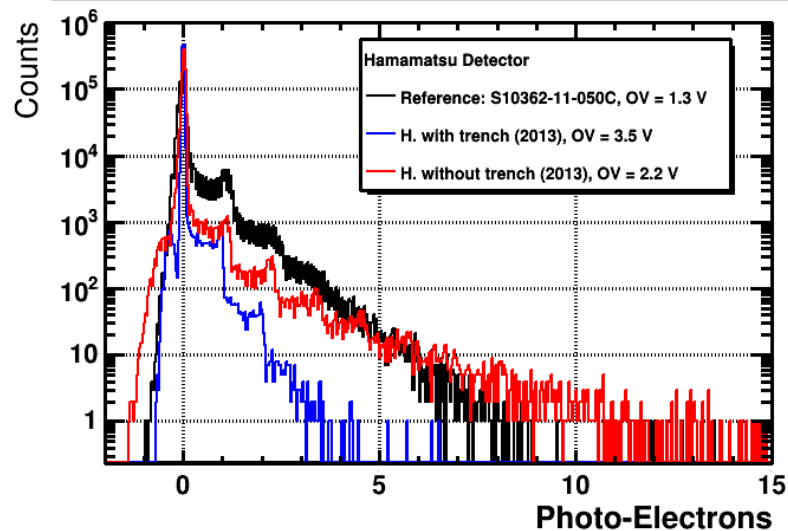
X-talk

- ❑ With low DCR (probability for two random pulses within shaping window small), the probability of x-talk is given by ratio $DCR_{th=1.5\text{ pe}}/DCR_{th=0.5\text{ pe}}$
- ❑ Two methods (systems) were used to measure x-talk.
 - ❑ Use a fast (**single channel**) amplifier (FEMTO 2GHz bandwidth) and record threshold scan. This allows to measure **x-talk without after-pulsing** due to the fast shaping.
 - ❑ Record dark spectrum with custom **multichannel data acquisition** system based on a VATA64 chip (64 channels, >50ns shaping time, sample and hold mode with serial readout, 12-bit ADC). This **cannot separate x-talk and after-pulsing** due to the slow shaping.
- ❑ The difference between the two methods allows to estimate the effect from after-pulsing.

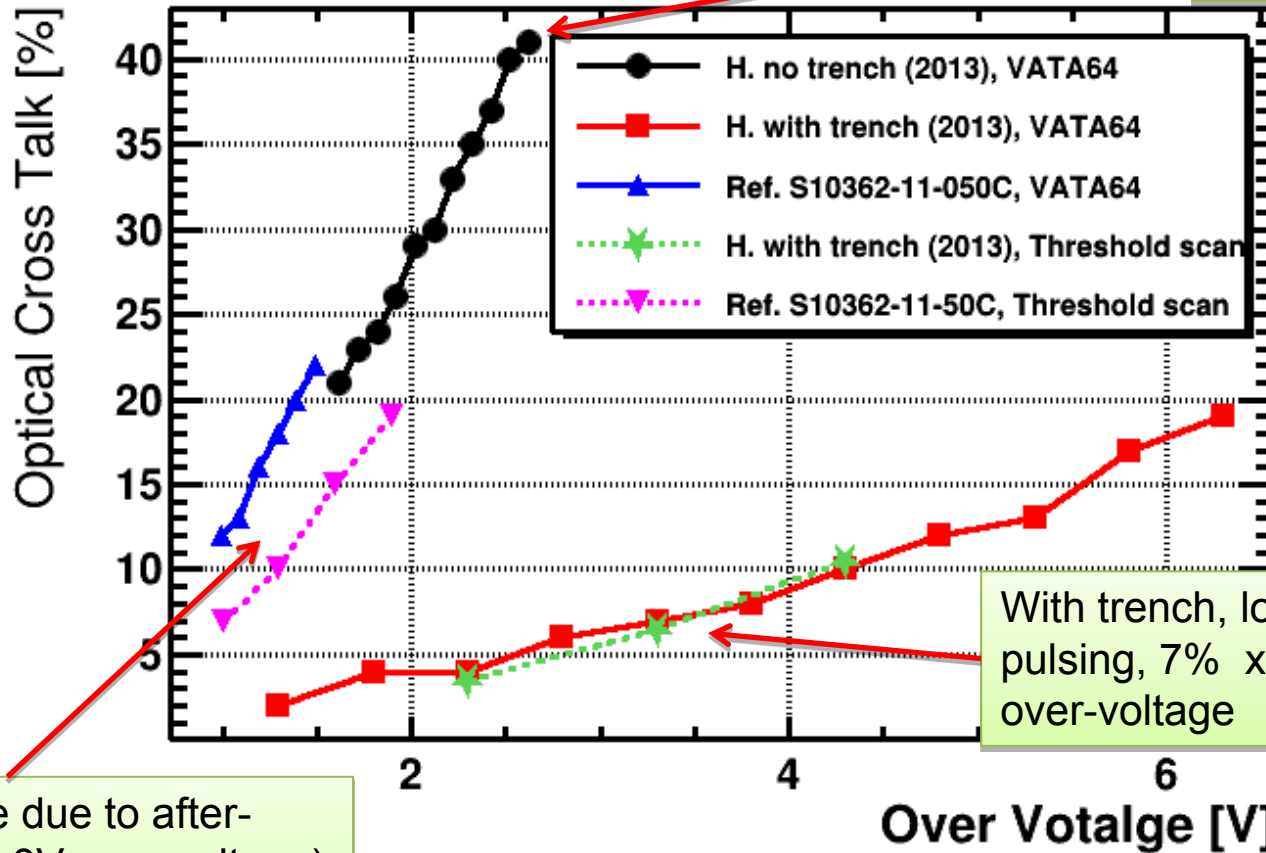
Hamamatsu, 50um pixel with trench (2013), different over-voltages, threshold scan.



Hamamatsu, 50um pixel, standard (ref.), with trench (2013), without trench (2013), at typical over-voltage, recorded with VATA64.



X-talk Hamamatsu (50um pixels)



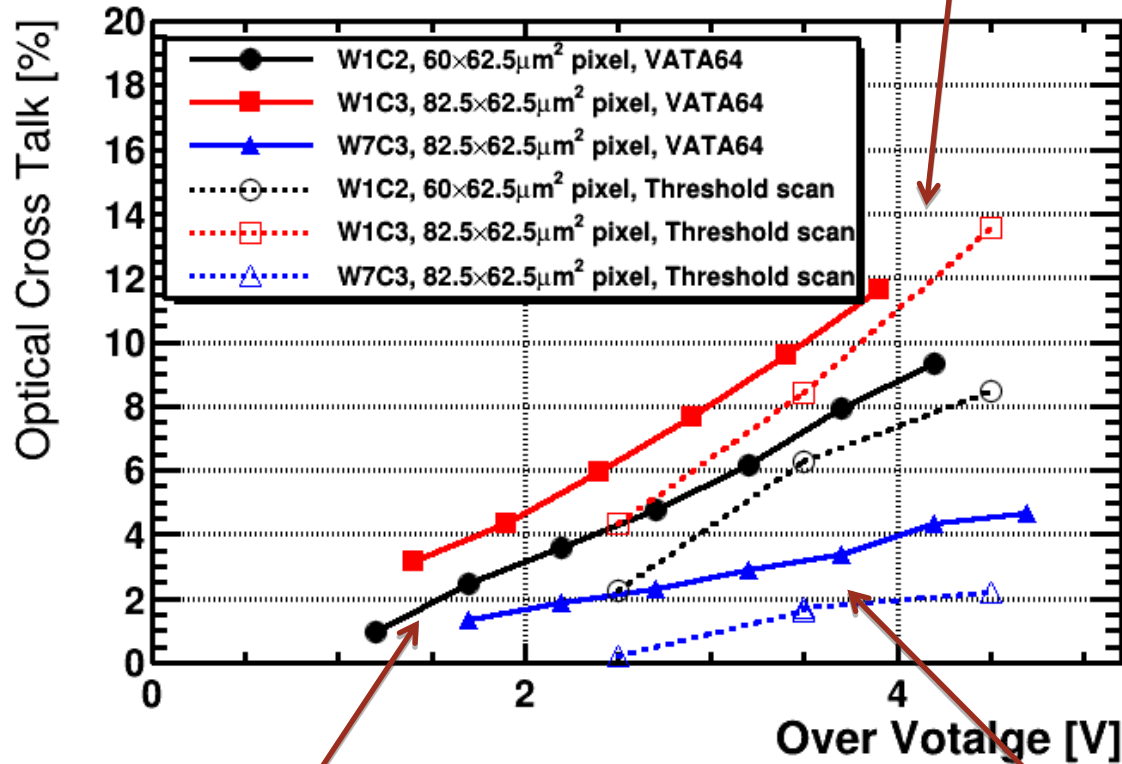
No trench, extremely high x-talk

With trench, low after-pulsing, 7% x-talk at 3.5V over-voltage

Difference due to after-pulsing (1.3V over-voltage) (17% vs 10%)

X-talk KETEK

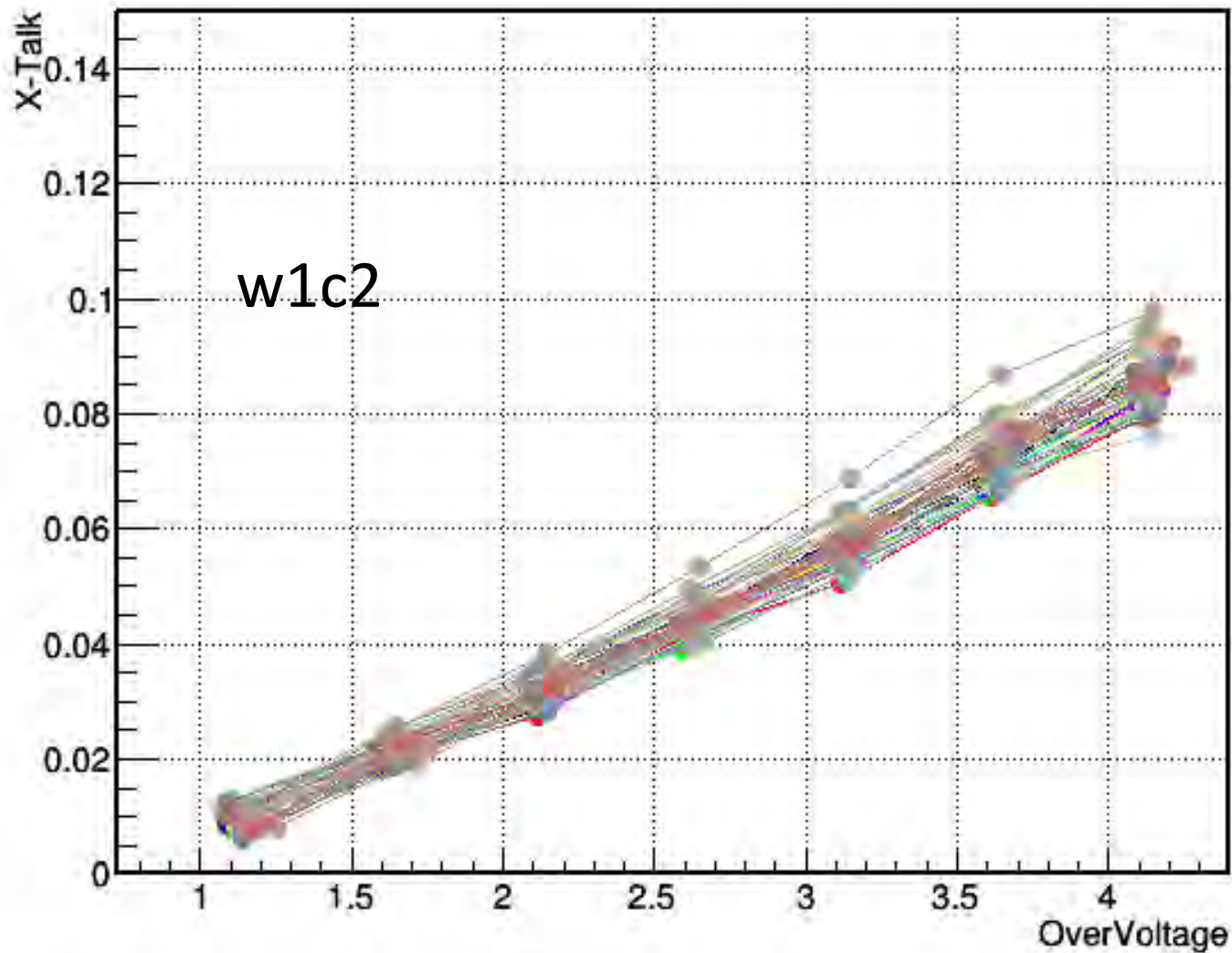
W1C3, with trench, large pixels
(3.5V over-voltage) (10% vs
8%)



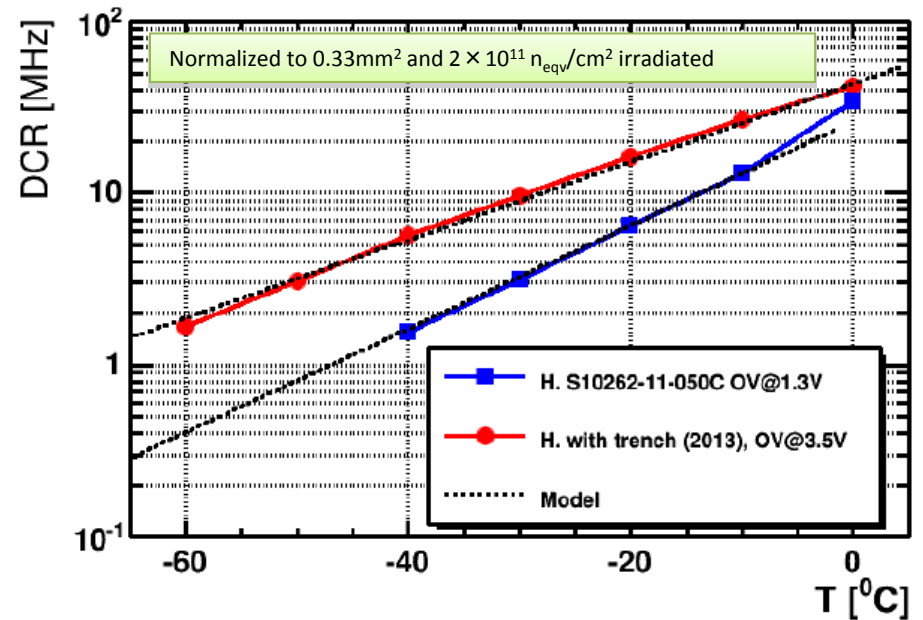
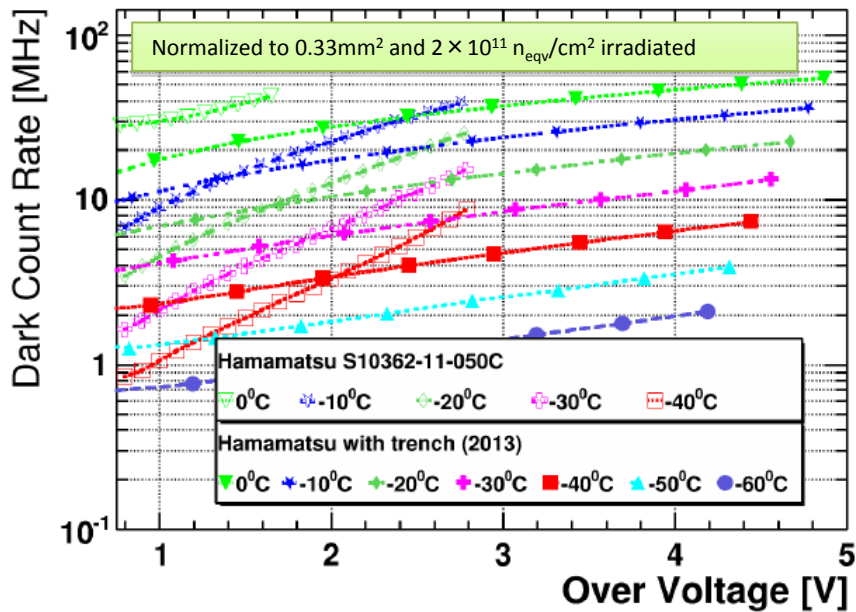
W1C2, with trench,
small pixels (3.5V
over-voltage) (8%
vs 7%)

W7C3, double trench,
large pixels (3.5V over-
voltage) (3% vs 2%)

Multichannel KETEK x-talk + afterpulse



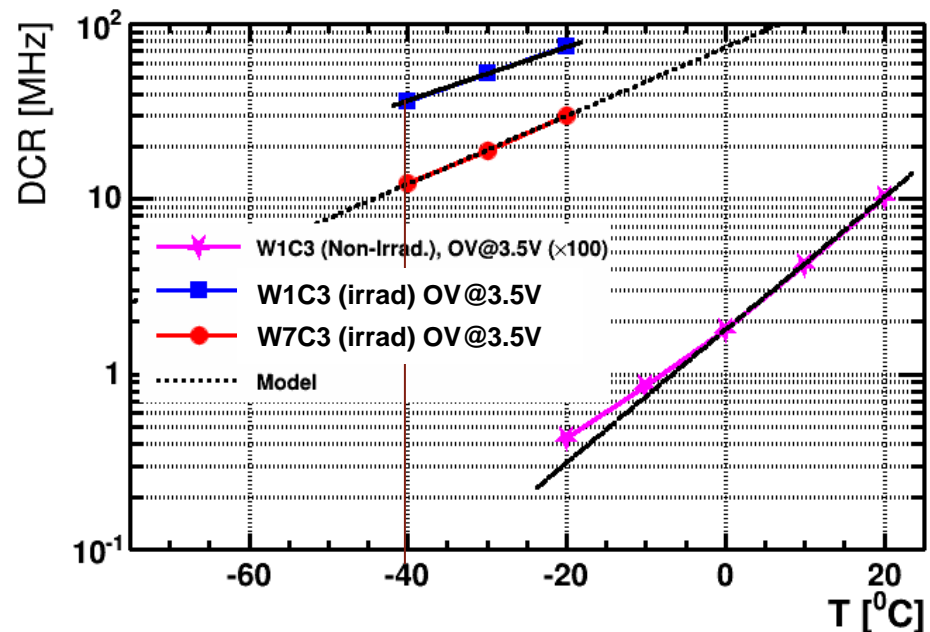
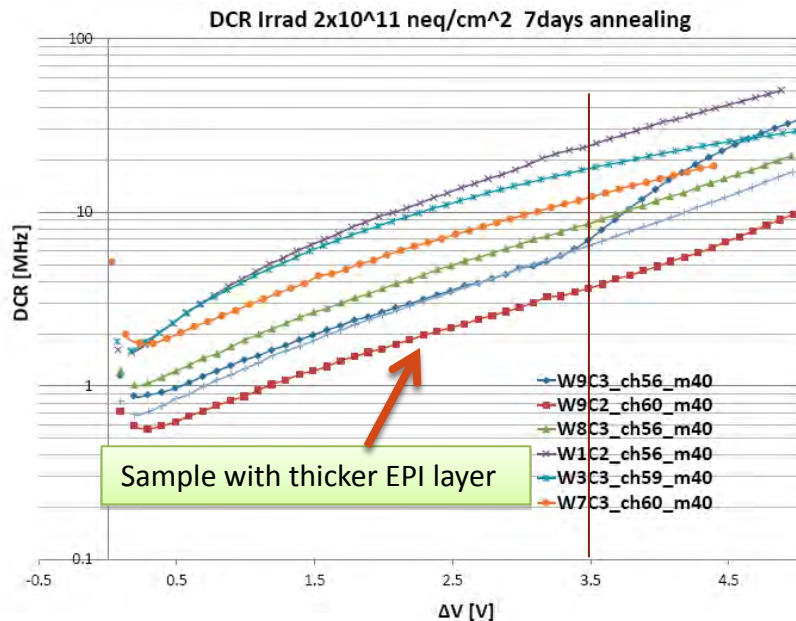
DCR for irradiated Hamamatsu detector



- ❑ The temperature dependence of the DCR is an important characteristic for the SciFi Tracker in LHCb. **Cooling to -40 °C** is foreseen to reduce the DCR to an acceptable level.
- ❑ We express the dependence in a temperature difference required to reduce the DCR by a factor 2 ($K_{1/2}$). The temperature dependence of the DCR is related to **different SiPM technologies**.
 - ❑ Hamamatsu S10362-11-050C, after irradiation $K_{1/2}=10^\circ\text{C}$
 - ❑ Hamamatsu detector with trenches (2013), after irradiation $K_{1/2}=12.8^\circ\text{C}$
- ❑ The detector with trenches (2013) can work at a **higher over-voltage** (to increase the PDE) but this increases the DCR!
- ❑ The detectors were annealed after irradiation (at 40 °C, one week) to reduce the DCR. **Annealing effect** can reduce the DCR by **a factor 2-2.5** for detectors operated at low temperature.

DCR for irradiated KETEK detector

Detector with 0.33mm^2 area and $2 \times 10^{11} \text{ n}_{\text{eqv}}/\text{cm}^2$ irradiated



- ❑ The temperature $K_{1/2}$ dependence of the DCR also changes between, before and after irradiation.
- ❑ The DCR for the double trench KETEK device is a factor 2-3 higher than Hamamatsu with trench, at 3.5V over-voltage and -40°C .

Noise cluster rate

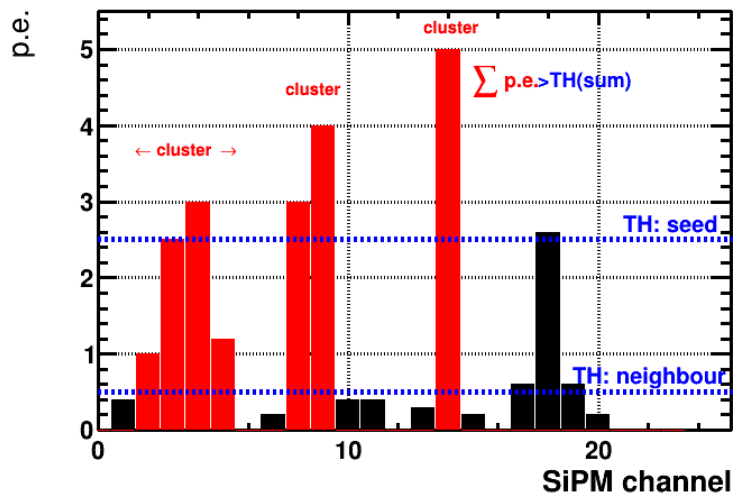
The noise cluster rate f_c is defined as the frequency of noise clusters for a 128Ch SiPM array which depends on:

DCR: the thermal noise increase with over-voltage (ΔV), depends on the temperature (T), the total surface of the detector (S) and the neutron fluence (N_{fluence})

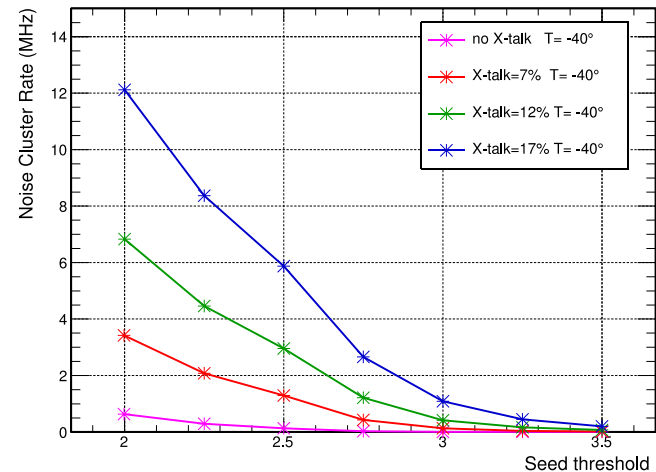
Clustering algorithm: the algorithm combines single channels into clusters, depends on the thresholds

X-talk: The pixel to pixel optical x-talk probability increases linearly with ΔV and increases significantly the f_c

Illustration of the clustering algorithm



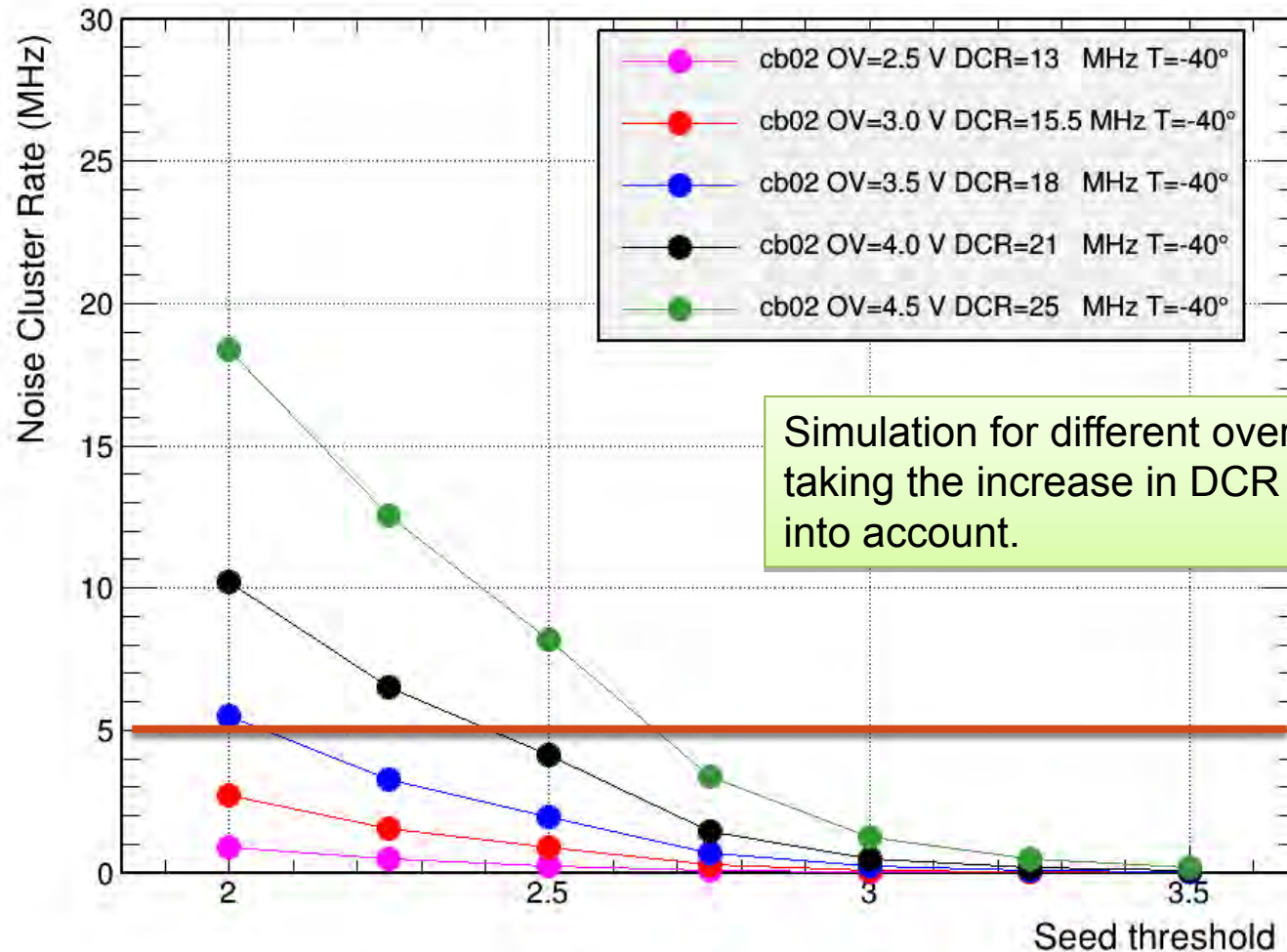
Simulation for different x-talk



After-pulsing: Small effect for LHCb SciFi application (because of very fast shaping), AP acts like DCR.

Shaping: Fast integration and shaping $O(20 \text{ ns})$ allows to cope with high DCR

Noise cluster rate for different ΔV

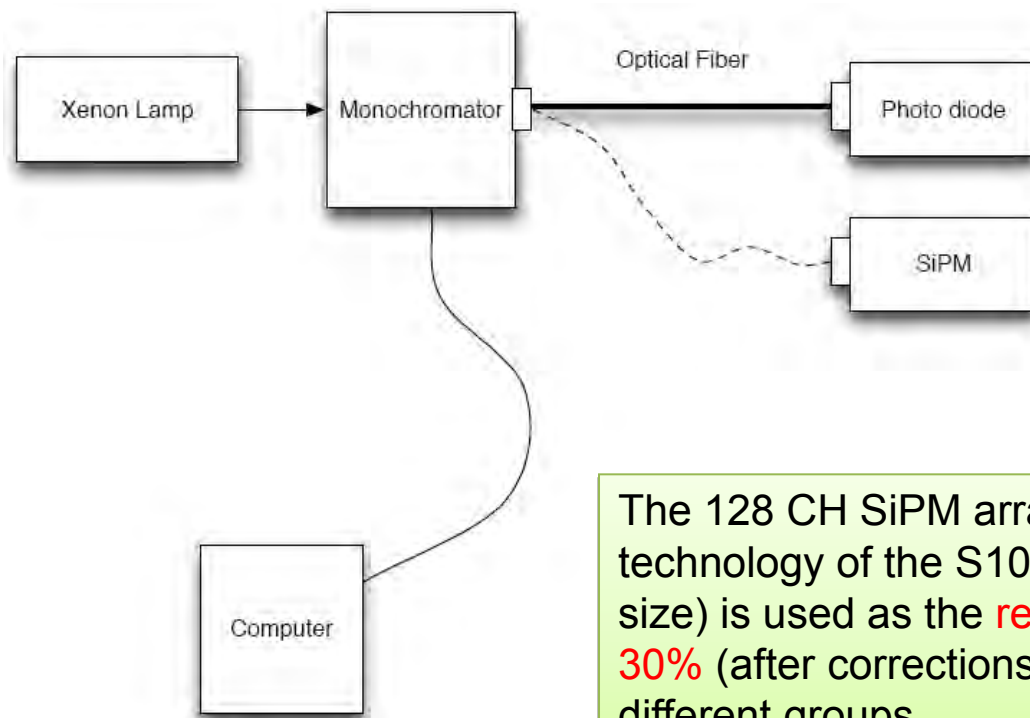


Photon Detection Efficiency

We perform a **relative Photon Detection Efficiency** (PDE) measurement:

$$\text{PDE}_{\text{rel,SiPM}}(\lambda) \propto (I_{\text{SiPM}}(\lambda) - I_{\text{Dark}}) / (1 + P_{\text{x-talk}}) / G * \text{QE}_{\text{PD}} / I_{\text{PD}}(\lambda)$$

Corrections for: **Dark current** (I_{dark}), **x-talk** (+after pulse) ($P_{\text{x-talk}}$), **lamp emission** ($I_{\text{PD}}(\lambda)$)



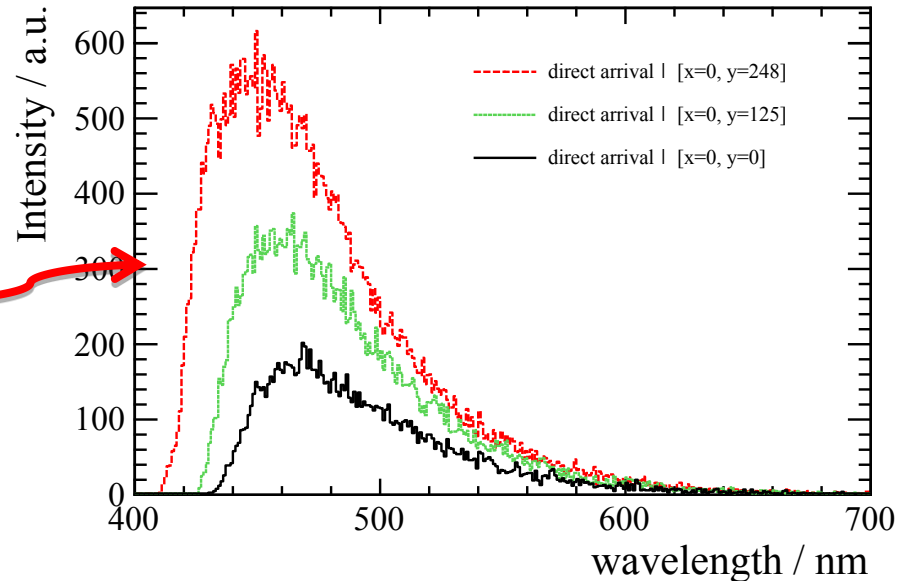
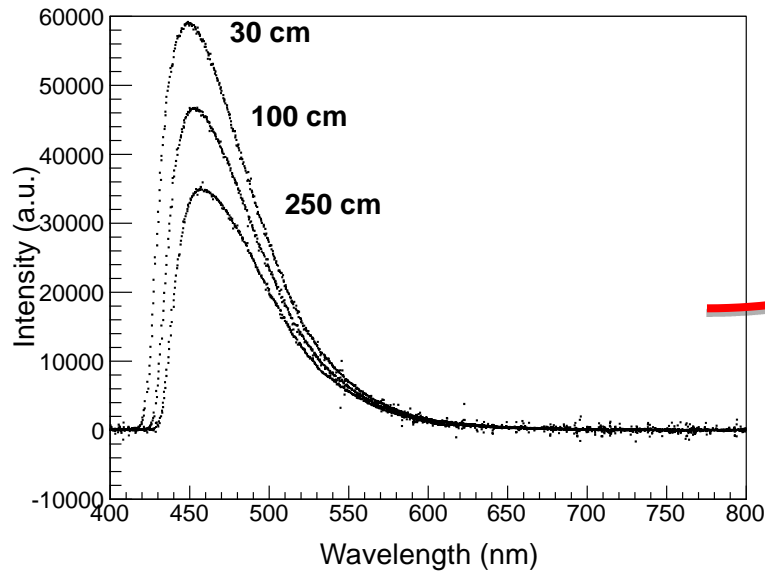
- **Calibrated light source** with photo diode
- **Monochromator** for wavelength selection
- Light coupled to optical fibre and optional **illuminating PD or SiPM**

The 128 CH SiPM array from **Hamamatsu** (based on the technology of the S10362-11-050C with adapted pixel size) is used as the **reference and its peak PDE is set to 30%** (after corrections). This value has been confirmed by different groups.

Emission spectrum of the SCSF-78MJ fibre

SCSF-78MJ

Expected after irradiation (35kGy) based on MC study

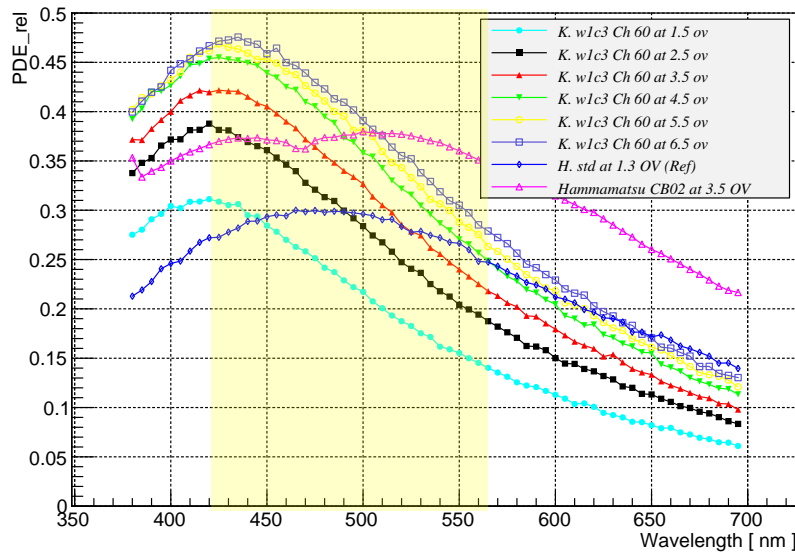


Non irradiated: Fibre emission spectrum (SCSF-78MJ). It extends from 400 to 600 nm and peaks at 450 nm.

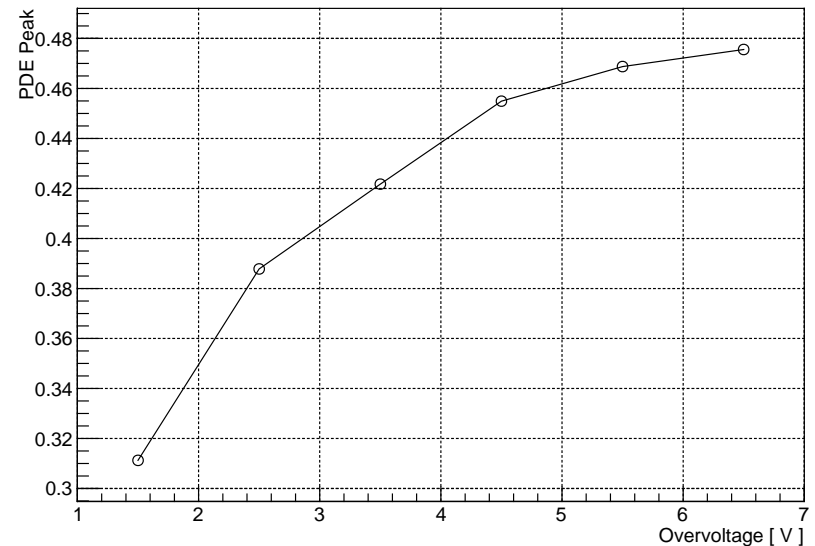
Irradiated fibre: The emission spectrum changes with irradiation. The simulated spectrum, taking into account a graded irradiation, shows a **green shift**.

PDE Hamamatsu and KETEK

Relative PDE w1c3 for different OV



PDE Peak in function of the overvoltage w1c3



- ❑ The emission spectrum from a long and irradiated fibre peaks at 480nm and is therefore green shifted compared to the peak PDE of SiPMs, especially for KETEK.
- ❑ The **Hamamatsu with trench (2013)** has a **peak PDE of 37%** and has a rather **flat** PDE over the full emission spectrum of the fibre.
- ❑ The **KETEK** detectors tested reach a **peak PDE of up to 43%** at 3.5V over-voltage.
- ❑ The **weighted integral over the emission spectrum** of the fibre reaches identical values for Hamamatsu (**pink line**) and KETEK (**red line**) (each detector with trench and at 3.5V over-voltage)

Summary

Detector type	H. S10262-11-050C	H. with trench (2013)	K. W1C2, with trench	K. W9C2, with trench	K. W7C3, double trench
Surface [mm ²]	1	1	1/3	1/3	1/3
Pixel size [μm ²]	50 × 50	50 × 50	60 × 62.5	60 × 62.5	82.5 × 62.5
T _C [mV/K]	56	53	15	26	22
Over-voltage [V]	1.3	3.5	3.5	3.5	3.5
X-talk + After-pulsing	17%	7%	8%	9%	3%
V _{BD} [V]	69	55	23.5	23.5	32.4
Gain [e/PE]	0.75 × 10 ⁶	2.0 × 10 ⁶	8.5 × 10 ⁶	6.4 × 10 ⁶	9.5 × 10 ⁶
PDE @peak	30%	37%	42%	41%	40%
Weighted PDE integral	1.26	1.61	1.44	na	1.47
Scaled DCR in [MHz] at -40°C, 2x10 ¹¹ n _{eqv} /cm ² , 1/3mm ²	1.5	6	22	3.8	12

- ❑ For LHCb SciFi Tracker we evaluated custom SiPM arrays from KETEK and Hamamatsu, which both have **high PDE**, **low x-talk** and **sufficient radiation hardness**.
- ❑ The KETEK technology shows a very **high peak PDE** where for the Hamamatsu the **broad sensitivity** gives an advantage for the green shifted emission spectrum of the fibre. They have **equal weighted integral of PDE** at the 3.5 V over-voltage.
- ❑ Detectors with (double) trenches have **low x-talk** and **better gain uniformity** due to lower T_C and higher over-voltage.
- ❑ The high DCR for these detectors require **cooling to -40 °C** in order to reach an acceptable noise cluster rate. K_{1/2} dependence for different technologies might lead to lower DCR.